Dual JK flip-flop with reset; negative-edge trigger Rev. 6 — 7 July 2021 Produc

Product data sheet

1. General description

The 74HC107; 74HCT107 is a dual negative edge triggered JK flip-flop featuring individual J and K inputs, clock (\overline{CP}) and reset (\overline{R}) inputs and complementary Q and \overline{Q} outputs. The reset is an asynchronous active LOW input and operates independently of the clock input. The J and K inputs control the state changes of the flip-flops as described in the mode select function table. The J and K inputs must be stable one set-up time prior to the HIGH-to-LOW clock transition for predictable operation. Inputs include clamp diodes that enable the use of current limiting resistors to interface inputs to voltages in excess of V_{CC}.

2. Features and benefits

- Wide supply voltage range from 2.0 V to 6.0 V
- CMOS low power dissipation
- High noise immunity
- Latch-up performance exceeds 100 mA per JESD 78 Class II Level B
- Complies with JEDEC standards:
 - JESD8C (2.7 V to 3.6 V)
 - JESD7A (2.0 V to 6.0 V)
- Input levels:
 - The 74HC107: CMOS levels
 - The 74HCT107: TTL levels
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C

3. Ordering information

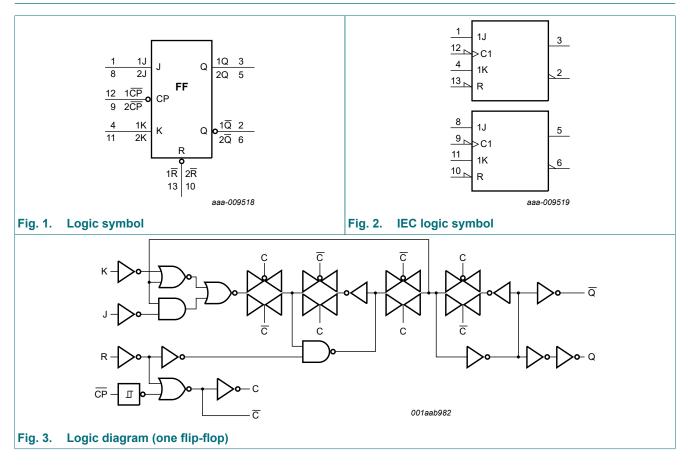
Type number	ype number Package								
	Temperature range	Name	Description	Version					
74HC107D	-40 °C to +125 °C	SO14	plastic small outline package; 14 leads;	SOT108-1					
74HCT107D			body width 3.9 mm						
74HC107PW	-40 °C to +125 °C	TSSOP14	plastic thin shrink small outline package; 14 leads; body width 4.4 mm	SOT402-1					

Table 1. Ordering information



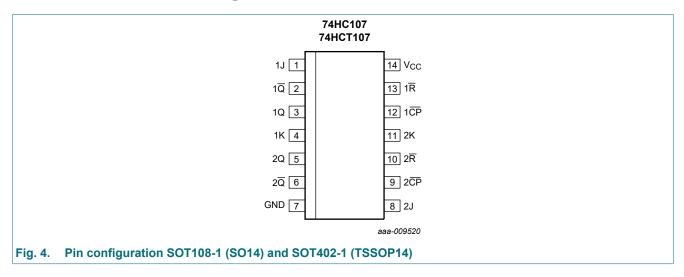
Dual JK flip-flop with reset; negative-edge trigger

4. Functional diagram



5. Pinning information

5.1. Pinning



5.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
1J, 2J	1, 8	synchronous J input
1 <u>Q</u> , 2 <u>Q</u>	2, 6	complement output
1Q, 2Q	3, 5	true output
1K, 2K	4, 11	synchronous K input
1 <u>CP</u> , 2 <u>CP</u>	12, 9	clock input (HIGH-to-LOW edge-triggered)
1 R , 2 R	13, 10	asynchronous reset input (active LOW)
GND	7	ground (0 V)
V _{CC}	14	supply voltage

6. Functional description

Table 3. Function table

H = HIGH voltage level; *h* = HIGH voltage level one set-up time prior to the HIGH-to-LOW clock transition;

L = LOW voltage level; *I* = LOW voltage level one set-up time prior to the HIGH-to-LOW clock transition;

q = state of referenced output one set-up time prior to the HIGH-to-LOW clock transition; X = don't care;

 \downarrow = HIGH-to-LOW clock transition.

Input				Output		Operating mode
R	СР	J	ĸ	Q	Q	
L	Х	X	X	L	Н	asynchronous reset
Н	Ļ	h	h	q	q	toggle
Н	Ļ	I	h	L	Н	load 0 (reset)
Н	Ļ	h	I	Н	L	load 1 (set)
Н	Ļ	I	I	q	q	hold (no change)

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{CC}	supply voltage			-0.5	+7.0	V
I _{IK}	input clamping current	V_{I} < -0.5 V or V_{I} > V_{CC} + 0.5 V	[1]	-	±20	mA
I _{ОК}	output clamping current	$V_{\rm O}$ < -0.5 V or $V_{\rm O}$ > $V_{\rm CC}$ + 0.5 V	[1]	-	±20	mA
lo	output current	V_{O} = -0.5 V to V_{CC} + 0.5 V		-	±25	mA
I _{CC}	supply current			-	50	mA
I _{GND}	ground current			-50	-	mA
T _{stg}	storage temperature			-65	+150	°C
P _{tot}	total power dissipation	T_{amb} = -40 °C to +125 °C	[2]	-	500	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For SOT108-1 (SO14) package: P_{tot} derates linearly with 10.1 mW/K above 100 °C.

For SOT402-1 (TSSOP14) package: Ptot derates linearly with 7.3 mW/K above 81 °C.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions		74HC107	7	74HCT107			Unit
			Min	Тур	Max	Min	Тур	Max	
V _{CC}	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
VI	input voltage		0	-	V _{CC}	0	-	V _{CC}	V
Vo	output voltage		0	-	V _{CC}	0	-	V _{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	-40	+25	+125	°C
Δt/ΔV	input transition rise and fall rate	V _{CC} = 2.0 V	-	-	625	-	-	-	ns/V
		V _{CC} = 4.5 V	-	1.67	139	-	1.67	139	ns/V
		V _{CC} = 6.0 V	-	-	83	-	-	-	ns/V

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		-40 °C t	o +85 °C	-40 °C to	o +125 °C	Unit
			Min	Тур	Мах	Min	Мах	Min	Max	
74HC10	7	1				1	1		1	
V _{IH}	HIGH-level	V _{CC} = 2.0 V	1.5	1.2	-	1.5	-	1.5	-	V
	input voltage	V _{CC} = 4.5 V	3.15	2.4	-	3.15	-	3.15	-	V
		V _{CC} = 6.0 V	4.2	3.2	-	4.2	-	4.2	-	V
V _{IL}	LOW-level	V _{CC} = 2.0 V	-	0.8	0.5	-	0.5	-	0.5	V
	input voltage	V _{CC} = 4.5 V	-	2.1	1.35	-	1.35	-	1.35	V
		V _{CC} = 6.0 V	-	2.8	1.8	-	1.8	-	1.8	V
V _{OH}	HIGH-level	V _I = V _{IH} or V _{IL}								
	output voltage	I _O = -20 μA; V _{CC} = 2.0 V	1.9	2.0	-	1.9	-	1.9	-	V
		I _O = -20 μA; V _{CC} = 4.5 V	4.4	4.5	-	4.4	-	4.4	-	V
		I _O = -20 μA; V _{CC} = 6.0 V	5.9	6.0	-	5.9	-	5.9	-	V
		I _O = -4.0 mA; V _{CC} = 4.5 V	3.98	4.32	-	3.84	-	3.7	-	V
		I _O = -5.2 mA; V _{CC} = 6.0 V	5.48	5.81	-	5.34	-	5.2	-	V
V _{OL}	LOW-level	V _I = V _{IH} or V _{IL}								
	output voltage	I _O = 20 μA; V _{CC} = 2.0 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 20 μA; V _{CC} = 4.5 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 20 μA; V _{CC} = 6.0 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 4.0 mA; V _{CC} = 4.5 V	-	0.15	0.26	-	0.33	-	0.4	V
		I _O = 5.2 mA; V _{CC} = 6.0 V	-	0.16	0.26	-	0.33	-	0.4	V
I	input leakage current	$V_{I} = V_{CC}$ or GND; $V_{CC} = 6.0$ V	-	-	±0.1	-	±1.0	-	±1.0	μA
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 6.0$ V	-	-	4.0	-	40	-	80	μA
CI	input capacitance		-	3.5	-					pF
74HCT1	07	1				1	I			
V _{IH}	HIGH-level input voltage	V_{CC} = 4.5 V to 5.5 V	2.0	1.6	-	2.0	-	2.0	-	V
V _{IL}	LOW-level input voltage	V_{CC} = 4.5 V to 5.5 V	-	1.2	0.8	-	0.8	-	0.8	V
V _{OH}	HIGH-level	V _I = V _{IH} or V _{IL} ; V _{CC} = 4.5 V								
	output voltage	I _O = -20 μA	4.4	4.5	-	4.4	-	4.4	-	V
		I _O = -4 mA	3.98	4.32	-	3.84	-	3.7	-	V
V _{OL}	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$								
	output voltage	I _O = 20 μA	-	0	0.1	-	0.1	-	0.1	V
		I _O = 4.0 mA	-	0.16	0.26	-	0.33	-	0.4	V
lı	input leakage current	$V_{I} = V_{CC}$ or GND; $V_{CC} = 5.5$ V	-	-	±0.1	-	±1.0	-	±1.0	μA
I _{CC}	supply current	V _I = V _{CC} or GND; I _O = 0 A; V _{CC} = 5.5 V	-	-	4.0	-	40	-	80	μA

Dual JK flip-flop with reset; negative-edge trigger

Symbol	Parameter	Conditions	25 °C		-40 °C to +85 °C		-40 °C to +125 °C		Unit	
			Min	Тур	Мах	Min	Мах	Min	Мах]
ΔI _{CC}	additional supply current	per input pin; $V_I = V_{CC} - 2.1 \text{ V}; I_O = 0 \text{ A};$ other inputs at V_{CC} or GND; $V_{CC} = 4.5 \text{ V}$ to 5.5 V								
		pin n CP , nJ	-	100	360	-	450	-	490	μA
		pin n R	-	65	234	-	293	-	319	μA
		pin nK	-	60	216	-	270	-	294	μA
CI	input capacitance		-	3.5	-	-	-	-	-	pF

10. Dynamic characteristics

Table 7. Dynamic characteristics

GND (ground = 0 V); C_L = 50 pF unless otherwise specified; for test circuit, see Fig. 7

Symbol	Parameter	Conditions		25 °C		-40 °C t	o +85 °C	-40 °C to	o +125 °C	Unit
			Min	Тур	Max	Min	Мах	Min	Max	1
74HC107	7					-		·		
t _{pd}	propagation	$n\overline{CP}$ to nQ; see <u>Fig. 5</u> [1]								
	delay	V _{CC} = 2.0 V	-	52	160	-	200	-	240	ns
		V _{CC} = 4.5 V	-	19	32	-	40	-	48	ns
		V _{CC} = 5.0 V; C _L = 15 pF	-	16	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	15	27	-	34	-	41	ns
	$n\overline{CP}$ to $n\overline{Q}$; see <u>Fig. 5</u>									
	V _{CC} = 2.0 V	-	52	160	-	200	-	240	ns	
		V _{CC} = 4.5 V	-	19	32	-	40	-	48	ns
		V _{CC} = 5.0 V; C _L = 15 pF	-	16	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	15	27	-	34	-	41	ns
		$n\overline{R}$ to nQ , $n\overline{Q}$; see <u>Fig. 6</u>								
		V _{CC} = 2.0 V	-	52	155	-	195	-	235	ns
		V _{CC} = 4.5 V	-	19	31	-	39	-	47	ns
		V _{CC} = 5.0 V; C _L = 15 pF	-	16	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	15	26	-	33	-	40	ns
t _t	transition	nQ, nQ; see <u>Fig. 5</u> [2]								
	time	V _{CC} = 2.0 V	-	19	75	-	95	-	110	ns
		V _{CC} = 4.5 V	-	7	15	-	19	-	22	ns
		V _{CC} = 6.0 V	-	6	13	-	16	-	19	ns

Dual JK flip-flop with reset; negative-edge trigger

Symbol	Parameter	Conditions		25 °C		-40 °C t	o +85 °C	-40 °C t	o +125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	1
t _W	pulse width	nCP input, HIGH or LOW; see Fig. 5								
		V _{CC} = 2.0 V	80	22	-	100	-	120	-	ns
		V _{CC} = 4.5 V	16	8	-	20	-	24	-	ns
		V _{CC} = 6.0 V	14	6	-	17	-	20	-	ns
		nR input, HIGH or LOW; see <u>Fig. 6</u>								
		V _{CC} = 2.0 V	80	22	-	100	-	120	-	ns
		V _{CC} = 4.5 V	16	8	-	20	-	24	-	ns
		V _{CC} = 6.0 V	14	6	-	17	-	20	-	ns
t _{rec}	recovery	nR to nCP; see <u>Fig. 6</u>								
	time	V _{CC} = 2.0 V	60	19	-	75	-	90	-	ns
		V _{CC} = 4.5 V	12	7	-	15	-	18	-	ns
		V _{CC} = 6.0 V	20	6	-	13	-	15	-	ns
t _{su}	set-up time	nJ, nK to nCP; see Fig. 5								
		V _{CC} = 2.0 V	100	22	-	125	-	150	-	ns
		V _{CC} = 4.5 V	20	8	-	25	-	30	-	ns
		V _{CC} = 6.0 V	17	6	-	21	-	26	-	ns
t _h	hold time	nJ, nK to n CP ; see <u>Fig. 5</u>								
		V _{CC} = 2.0 V	3	-6	-	3	-	3	-	ns
		V _{CC} = 4.5 V	3	-2	-	3	-	3	-	ns
		V _{CC} = 6.0 V	3	-2	-	3	-	3	-	ns
f _{max}	maximum	nCP input; see Fig. 5								
	frequency	V _{CC} = 2.0 V	6	23	-	4.8	-	4.0	-	MHz
		V _{CC} = 4.5 V	30	70	-	24	-	20	-	MHz
		V _{CC} = 5.0 V; C _L = 15 pF	-	78	-	-	-	-	-	MHz
		V _{CC} = 6.0 V	35	85	-	28	-	24	-	MHz
C _{PD}	power dissipation capacitance	per flip-flop; [3] $V_I = GND$ to V_{CC}	-	30	-	-	-	-	-	pF
74HCT1	07								-	
t _{pd}	propagation	nCP to nQ; see Fig. 5 [1]								
	delay	V _{CC} = 4.5 V	-	19	36	-	45	-	54	ns
		V _{CC} = 5.0 V; C _L = 15 pF	-	16	-	-	-	-	-	ns
		$n\overline{CP}$ to $n\overline{Q}$; see Fig. 5								
		V _{CC} = 4.5 V	-	21	36	-	45	-	54	ns
		V _{CC} = 5.0 V; C _L = 15 pF	-	18	-	-	-	-	-	ns
		nR to nQ, nQ; see <u>Fig. 6</u>								
		V _{CC} = 4.5 V	-	20	38	-	48	-	57	ns
		V _{CC} = 5.0 V; C _L = 15 pF	-	17	-	-	-	-	-	ns
t _t	transition	nQ, nQ; see <u>Fig. 5</u> [2]								
	time	V _{CC} = 4.5 V	-	7	15	-	19	-	22	ns

74HC_HCT107

Symbol Parameter Conditions 25 °C -40 °C to +85 °C -40 °C to +125 °C Unit Min Тур Max Min Max Min Max nCP input, HIGH or LOW; pulse width tw see Fig. 5 $V_{CC} = 4.5 V$ 16 9 20 24 _ ns _ nR input, HIGH or LOW; see Fig. 6 V_{CC} = 4.5 V 20 11 25 30 ns -_ nR to nCP; see Fig. 6 recovery t_{rec} time $V_{CC} = 4.5 V$ 14 8 18 21 ns _ _ _ nJ, nK to nCP; see Fig. 5 set-up time t_{su} V_{CC} = 4.5 V 20 7 25 30 _ _ ns nJ, nK to nCP; see Fig. 5 hold time t_h $V_{CC} = 4.5 V$ 5 -2 -5 _ 5 ns nCP input; see Fig. 5 f_{max} maximum frequency $V_{CC} = 4.5 V$ 30 66 _ 24 20 MHz _ -V_{CC} = 5.0 V; C_L = 15 pF MHz -73 ----per flip-flop; C_{PD} power [3] -30 pF _ _ _ _ dissipation $V_I = GND$ to $V_{CC} - 1.5 V$ capacitance

Dual JK flip-flop with reset; negative-edge trigger

 t_{pd} is the same as t_{PHL} , t_{PLH} . [1]

[2]

 t_t is the same as t_{THL} , t_{TLH} . C_{PD} is used to determine the dynamic power dissipation (P_D in μ W). [3] $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$ where: f_i = input frequency in MHz;

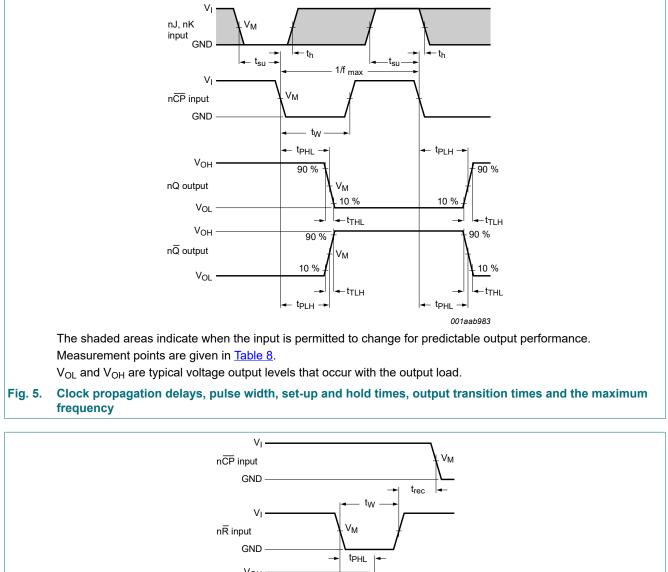
 f_o = output frequency in MHz;

 C_L = output load capacitance in pF;

V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_0) = \text{sum of outputs.}$



10.1. Waveforms and test circuit

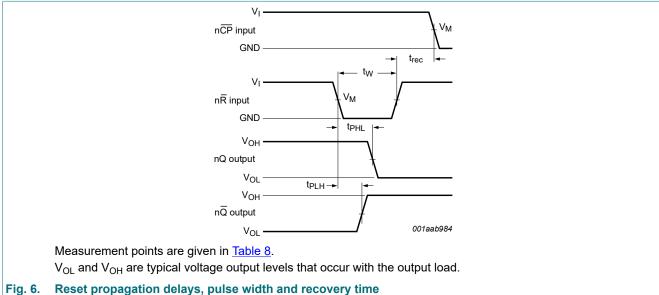


Table 8 Measurement noints

Table 0. Medsurement points						
Туре	Input	Output				
	VI	V _M	V _M			
74HC107	V _{CC}	0.5V _{CC}	0.5V _{CC}			
74HCT107	3 V	1.3 V	1.3 V			

Dual JK flip-flop with reset; negative-edge trigger

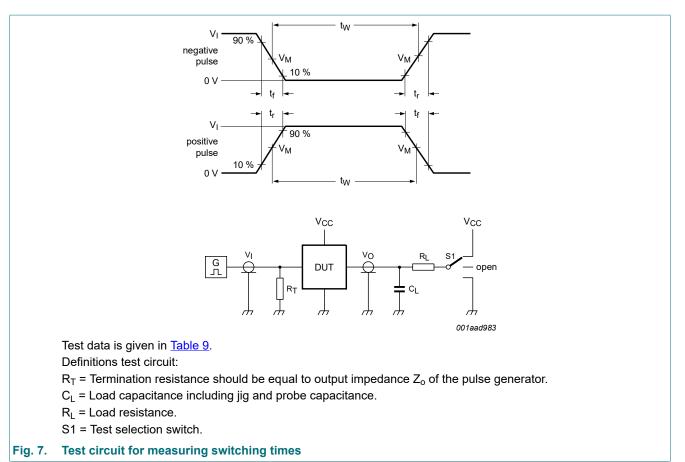


Table 9. Test data

Туре	Input	put			S1 position			
	VI	t _r , t _f	CL	RL	t _{PHL} , t _{PLH}	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ}	
74HC107	V _{CC}	6 ns	15 pF, 50 pF	1 kΩ	open	GND	V _{CC}	
74HCT107	3 V	6 ns	15 pF, 50 pF	1 kΩ	open	GND	V _{CC}	

11. Package outline

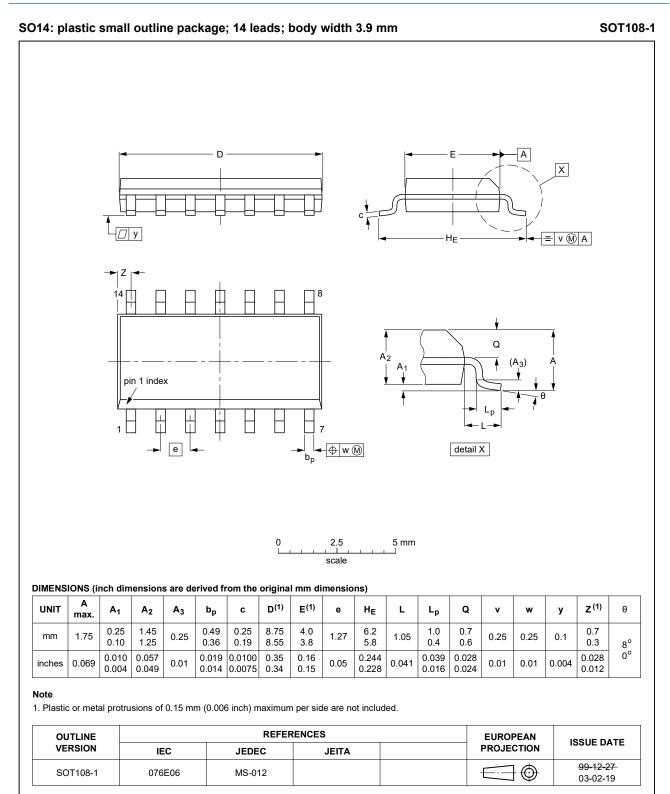


Fig. 8. Package outline SOT108-1 (SO14)

Dual JK flip-flop with reset; negative-edge trigger

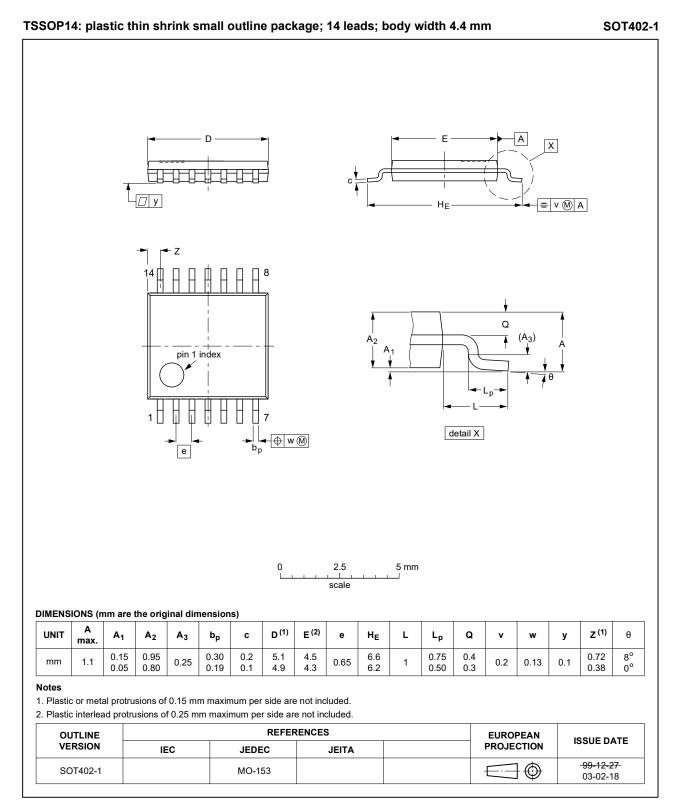


Fig. 9. Package outline SOT402-1 (TSSOP14)

12. Abbreviations

Table 10. Abbrev	Table 10. Abbreviations						
Acronym	Description						
CMOS	Complementary Metal-Oxide Semiconductor						
DUT	Device Under Test						
ESD	ElectroStatic Discharge						
HBM	Human Body Model						
MM	Machine Model						
TTL	Transistor-Transistor Logic						

13. Revision history

Fable 11. Revision history				
Document ID	Release date	Data sheet status	Change notice	Supersedes
74HC_HCT107 v.6	20210707	Product data sheet	-	74HC_HCT107 v.5
Modifications:	 The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia. Legal texts have been adapted to the new company name where appropriate. <u>Section 2</u> updated. <u>Section 7</u>: Derating values for P_{tot} total power dissipation have changed. Type number 74HC107DB (SOT337-1/SSOP14) removed. 			
74HC_HCT107 v.5	20151130	Product data sheet	-	74HC_HCT107 v.4
Modifications:	Type numbers 74HC107N and 74HCT107N (SOT27-1) removed.			
74HC_HCT107 v.4	20150126	Product data sheet	-	74HC_HCT107 v.3
Modifications:	Table 7: Power dissipation capacitance condition for 74HCT107 is corrected.			
74HC_HCT107 v.3	20131118	Product data sheet	-	74HC_HCT107_CNV v.2
Modifications:	 The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. Legal texts have been adapted to the new company name where appropriate. 			
74HC_HCT107_CNV v.2	19901201	Product specification	-	-

14. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

 Please consult the most recently issued document before initiating or completing a design.

- [2] The term 'short data sheet' is explained in section "Definitions".
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at <u>https://www.nexperia.com</u>.

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